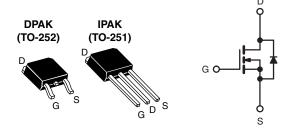


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	60					
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.10					
Q _g (Max.) (nC)	25					
Q _{gs} (nC)	5.8					
Q _{gd} (nC)	11					
Configuration	Single					



N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Surface Mount (IRFR024, SiHFR024)
- Straight Lead (IRFU024, SiHFU024)
- Available in Tape and Reel
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION							
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFR024-GE3	SiHFR024TR-GE3	SiHFR024TRL-GE3	SiHFU024-GE3			
Lood (Db) free	IRFR024PbF	IRFR024TRPbF ^a	-	IRFU024PbF			
Lead (Pb)-free	SiHFR024-E3	SiHFR024T-E3 ^a	-	SiHFU024-E3			

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T_C :	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	60	v	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		14		
Continuous Drain Current	I _D	9.0	А			
Pulsed Drain Current ^a	I _{DM}	56				
Linear Derating Factor			0.33	W/°C		
Linear Derating Factor (PCB Mount) ^e			1	0.020	W/ C	
Single Pulse Avalanche Energy ^b			E _{AS}	91	mJ	
Maximum Power Dissipation	D	42	w			
Maximum Power Dissipation (PCB Mount) ^e	PD	2.5	vv			
Peak Diode Recovery dV/dtc	dV/dt	5.5	V/ns			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C			
Soldering Recommendations (Peak Temperature) ^d		260				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 541 µH, $R_g = 25 \Omega$, $I_{AS} = 14 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq 17$ A, dI/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).



THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	-	110			
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C, I _D = 1 mA	-	0.073	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 60 V, V _{GS} = 0 V	-	-	25	μA
-		-	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 8.4 A^b$	-	-	0.10	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 25 V, I _D = 8.4 A ^b	6.2	-	-	S
Dynamic		÷					i
Input Capacitance	Ciss		$V_{GS} = 0 V$,	-	640	-	
Output Capacitance	Coss		$V_{DS} = 25 V,$	-	360	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	79	-	
Total Gate Charge	Qg			-	-	25	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$ $I_D = 17 A, V_{DS} = 48 V,$ see fig. 6 and 13^{b}		-	-	5.8	nC
Gate-Drain Charge	Q _{gd}	1		-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	tr	Vpp	= 30 V, I _D = 17A,	-	58	-	
Turn-Off Delay Time	t _{d(off)}	$R_{G} = 18 \Omega$, $R_{D} = 1.7 \Omega$, see fig. 10 ^b		-	25	-	ns
Fall Time	t _f	1		-	42	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") f		-	4.5	-	nH
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	14	А
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	56	
Body Diode Voltage	V _{SD}	T _J = 25 °C	$I_{S} = 14 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	17 A JI/JH 100 A/ b	-	88	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 ^{\circ}{\rm C}, I_{\rm F}$	= 17 A, dl/dt = 100 A/µs ^b	-	0.29	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	$V_{\rm S}$ and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

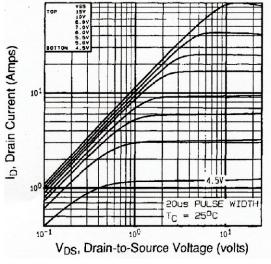


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

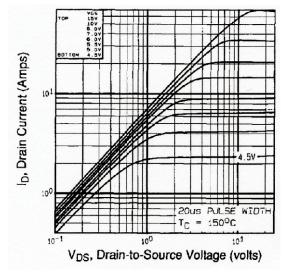
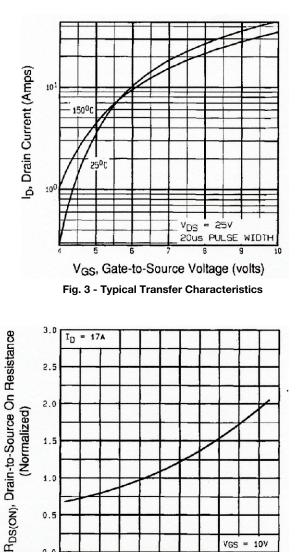


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$



1.5

1.0

0.5

0.0

-60 -40 -20 0

T_J, Junction Temperature (°C) Fig. 4 - Normalized On-Resistance vs. Temperature

20 40 60 VGS = 10V

140 160

80 100 120

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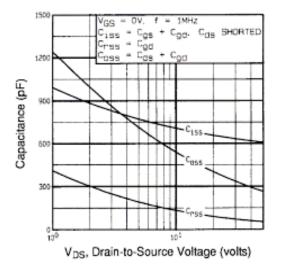
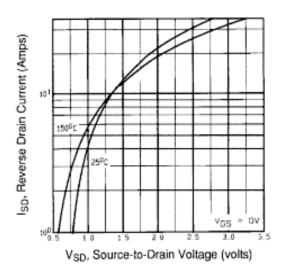
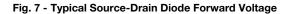


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





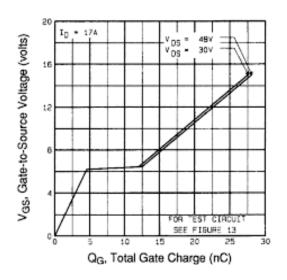


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

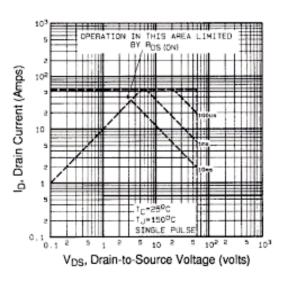


Fig. 8 - Maximum Safe Operating Area

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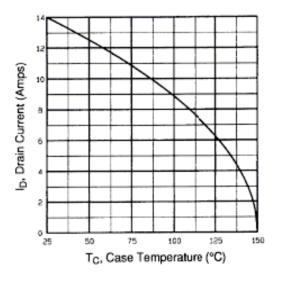


Fig. 9 - Maximum Drain Current vs. Case Temperature

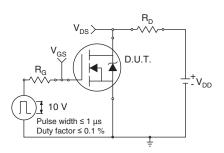


Fig. 10a - Switching Time Test Circuit

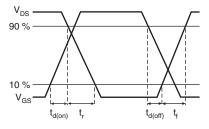


Fig. 10b - Switching Time Waveforms

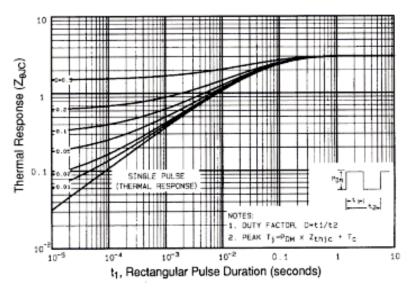


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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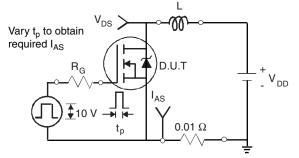


Fig. 12a - Unclamped Inductive Test Circuit

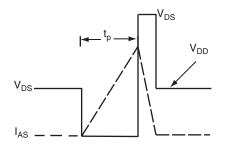


Fig. 12b - Unclamped Inductive Waveforms

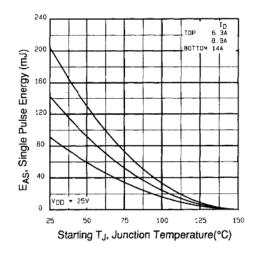


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

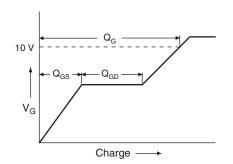


Fig. 13a - Basic Gate Charge Waveform

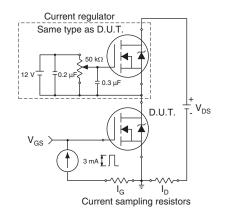


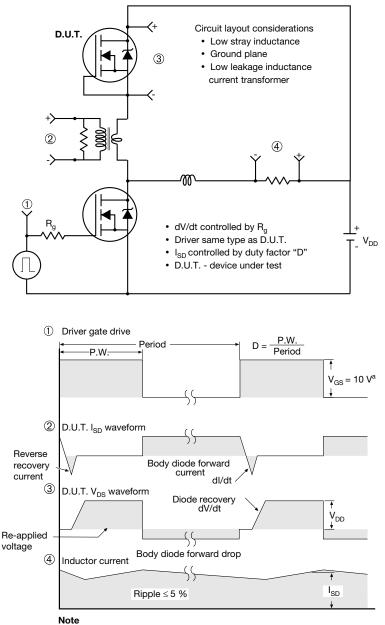
Fig. 13b - Gate Charge Test Circuit

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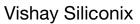


a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

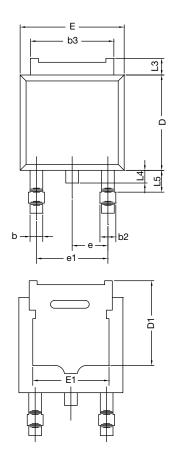
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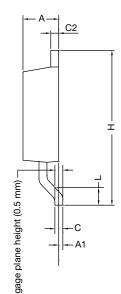
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TO-252AA Case Outline





	MILLIN	IETERS	INCHES				
DIM.	MIN.	MAX.	MIN.	MAX.			
А	2.18	2.38	0.086	0.094			
A1	-	0.127	-	0.005			
b	0.64	0.88	0.025	0.035			
b2	0.76	1.14	0.030	0.045			
b3	4.95	5.46	0.195	0.215			
С	0.46	0.61	0.018	0.024			
C2	0.46	0.89	0.018	0.035			
D	5.97	6.22	0.235	0.245			
D1	4.10	-	0.161	-			
Е	6.35	6.73	0.250	0.265			
E1	4.32	-	0.170	-			
Н	9.40	10.41	0.370	0.410			
е	2.28	BSC	0.090	90 BSC			
e1	4.56	BSC	0.180 BSC				
L	1.40	1.78	0.055	0.070			
L3	0.89	1.27	0.035	0.050			
L4	-	1.02	-	0.040			
L5	1.01	1.52	0.040	0.060			
ECN: T16- DWG: 534	0236-Rev. P, [•] 7	16-May-16					

Notes

• Dimension L3 is for reference only.



TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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